

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT														
NATURE OF CONVEYANCE:	ASSIGNMENT														
CONVEYING PARTY DATA															
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Tae Kwang KIM</td> <td>03/18/2010</td> </tr> <tr> <td>Chung Hoon LEE</td> <td>03/23/2010</td> </tr> <tr> <td>Do Hyung KIM</td> <td>03/18/2010</td> </tr> <tr> <td>Seung Ryeol RYU</td> <td>03/18/2010</td> </tr> <tr> <td>Chan Sung JEONG</td> <td>03/18/2010</td> </tr> <tr> <td>Woong Joon HWANG</td> <td>03/18/2010</td> </tr> </tbody> </table>		Name	Execution Date	Tae Kwang KIM	03/18/2010	Chung Hoon LEE	03/23/2010	Do Hyung KIM	03/18/2010	Seung Ryeol RYU	03/18/2010	Chan Sung JEONG	03/18/2010	Woong Joon HWANG	03/18/2010
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CORRESPONDENCE DATA															
Fax Number: (703)288-5139 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i> Phone: 703-288-5105 Email: patent@park-law.com Correspondent Name: H.C. Park & Associates, PLC Address Line 1: 8500 Leesburg Pike, Suite 7500 Address Line 4: Vienna, VIRGINIA 22182															
ATTORNEY DOCKET NUMBER:	P3768US00														
NAME OF SUBMITTER:	Hae-Chan Park														

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PATENT
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Total Attachments: 6

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ASSIGNMENT

Whereas, Assignor has invented certain new and useful processes, machines, articles of manufacture, compositions of matter, and/or improvements thereof ("Invention") disclosed in

☒ an application for United States Letters Patent entitled **LED PACKAGE AND BACKLIGHT UNIT USING THE SAME** ("Application");

☐ upon which United States Letters Patent, Patent Number _____, has issued ("Patent");

Whereas, Assignor desires to convey all rights, titles, and interests in and to the same to:

Seoul Semiconductor Co., Ltd.
148-29, Gasan-dong, Geumcheon-gu
158-801 Seoul
Republic of Korea

Seoul Semiconductor Co., Ltd. herein further referred to as ("Assignee").

Now, for valuable consideration by Assignee to Assignor, the receipt of which is hereby acknowledged, and for other good and valuable consideration, Assignee and Assignor hereby agree as follows:

Assignor hereby conveys, assigns, sells and transfers to Assignee all rights, title and interests in and to the Invention disclosed in said application and in and to any Letters Patent of the United States (US), any continuation, division, renewal, or substitute thereof, and hereby grant to Assignee the right to apply in its own name for patents or Inventor's certificates and related rights heretofore or hereafter filed for the Invention in any and all countries, including (without limitation) all rights to claim priority based thereon, all patents granted thereon and all reissues, extensions and renewals thereof.

Assignor hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment.

Assignor further covenants that Assignee will, upon Assignee's request, be provided promptly with all pertinent facts and documents relating to the Invention, Patent, Application and any patents granted thereon, as may be known and accessible to Assignor, and Assignor will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to Assignee or Assignee's legal representative any and all papers, instruments or affidavits required to apply for, protect, obtain, maintain, issue, defend and enforce the Application, Patent, Invention, whether in the US or any and all foreign countries and any patents granted thereon and/or for obtaining any reissue or reissues of any patent which may be granted for the invention and perform such further acts which may be necessary or desirable to carry out the intent of this agreement as the Assignee thereof shall hereafter require and prepare at assignee's expense.



IN WITNESS WHEREOF, Assignor has hereunto set hand and seal.

First Inventor's Name: Tae Kwang KIM

Address: 1B-35, 727-5, Wonsi-dong, Danwon-gu
Ansan-si, Gyeonggi-do 425-851
Republic of Korea

First Inventor's Signature:

Date:

Second Inventor's Name: Chung Hoon LEE

Address: 1B-35, 727-5, Wonsi-dong, Danwon-gu
Ansan-si, Gyeonggi-do 425-851
Republic of Korea

Second Inventor's Signature:

Date:

Third Inventor's Name: Do Hyung KIM

Address: 1B-35, 727-5, Wonsi-dong, Danwon-gu
Ansan-si, Gyeonggi-do 425-851
Republic of Korea

Third Inventors' Signature:

Date:



Fourth Inventor's Name: Seung Ryeol RYU

Address: 1B-35, 727-5, Wonsi-dong, Danwon-gu
Ansan-si, Gyeonggi-do 425-851
Republic of Korea

Fourth Inventor's Signature:

Date:

2010. 3. 18

Fifth Inventor's Name: Chan Sung JEONG

Address: 1B-35, 727-5, Wonsi-dong, Danwon-gu
Ansan-si, Gyeonggi-do 425-851
Republic of Korea

Fifth Inventor's Signature:

Date:

2010. 3. 18

Sixth Inventor's Name: Woong Joon HWANG

Address: 1B-35, 727-5, Wonsi-dong, Danwon-gu
Ansan-si, Gyeonggi-do 425-851
Republic of Korea

Sixth Inventor's Signature:

Date:

2010. 3. 18



ASSIGNMENT

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Assignor hereby conveys, assigns, sells and transfers to Assignee all rights, title and interests in and to the Invention disclosed in said application and in and to any Letters Patent of the United States (US), any continuation, division, renewal, or substitute thereof, and hereby grant to Assignee the right to apply in its own name for patents or Inventor's certificates and related rights heretofore or hereafter filed for the Invention in any and all countries, including (without limitation) all rights to claim priority based thereon, all patents granted thereon and all reissues, extensions and renewals thereof.

Assignor hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment.

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First Inventor's Name: Tae Kwang KIM

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Ansan-si, Gyeonggi-do 425-851
Republic of Korea

First Inventor's Signature: _____

Date: _____

Second Inventor's Name: Chung Hoon LEE

Address: 1B-35, 727-5, Wonsi-dong, Danwon-gu
Ansan-si, Gyeonggi-do 425-851
Republic of Korea

Second Inventor's Signature: _____

Date: _____

Third Inventor's Name: Do Hyung KIM

Address: 1B-35, 727-5, Wonsi-dong, Danwon-gu
Ansan-si, Gyeonggi-do 425-851
Republic of Korea

Third Inventors' Signature: _____

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Address: 1B-35, 727-5, Wonsi-dong, Danwon-gu
Ansan-si, Gyeonggi-do 425-851
Republic of Korea

Fourth Inventor's Signature: _____

Date: _____

Fifth Inventor's Name: Chan Sung JEONG

Address: 1B-35, 727-5, Wonsi-dong, Danwon-gu
Ansan-si, Gyeonggi-do 425-851
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Fifth Inventor's Signature: _____

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